

# PUBLIC ANNOUNCEMENT

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## BONDZTEK

*Registered Proprietor* : BONDZTEK EQUIPMENT SDN. BHD.

*Application No* : TM2022023541, TM2022023542, TM2022023544  
& TM2022023545

*Classification* : 07, 09, 35 & 37

We hereby notify you that the above-mentioned Trademark has been granted with Trademark Registration by the Intellectual Property Corporation of Malaysia (MYIPO) and has now been accorded with statutory protection under the Trademarks Act 2019.

The Registered Proprietor of this Application is given the full and exclusive rights to use the Trademark in relation to its registered good and/or services. Further details can be found in the Announcement published on our website.

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